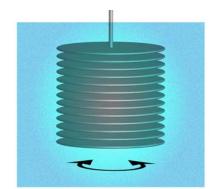
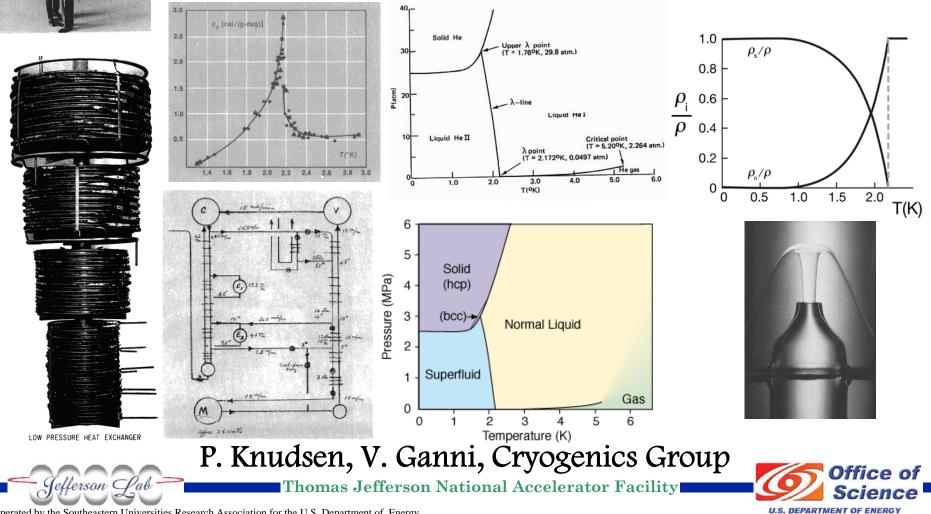


Cold End Process Options for Nominal 2-K Helium System Improvements





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- Introduction
 - Refrigeration below 4.5-K typically involves *subatmospheric helium* at some point in the process
 - Since processes used for large accelerators operate typically between 1.8 to 2.1 K (i.e., 16 to 42 mbar), will refer to these as *nominally 2-K*

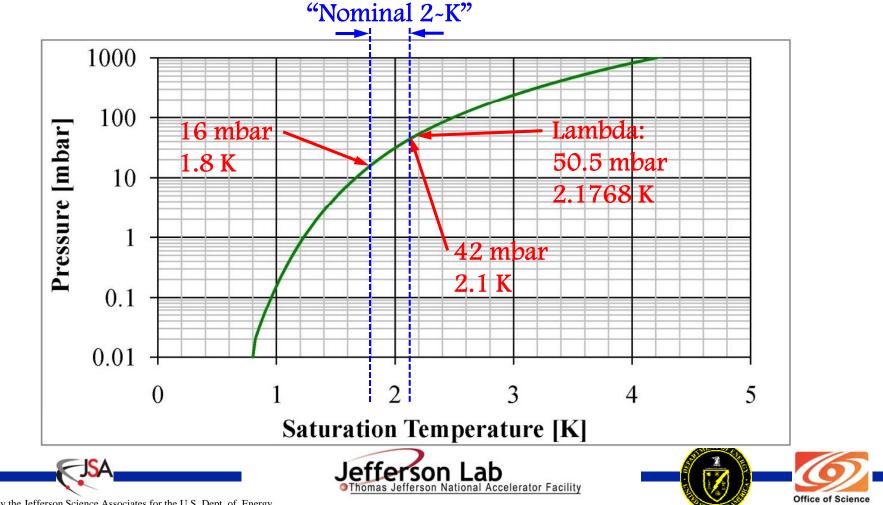




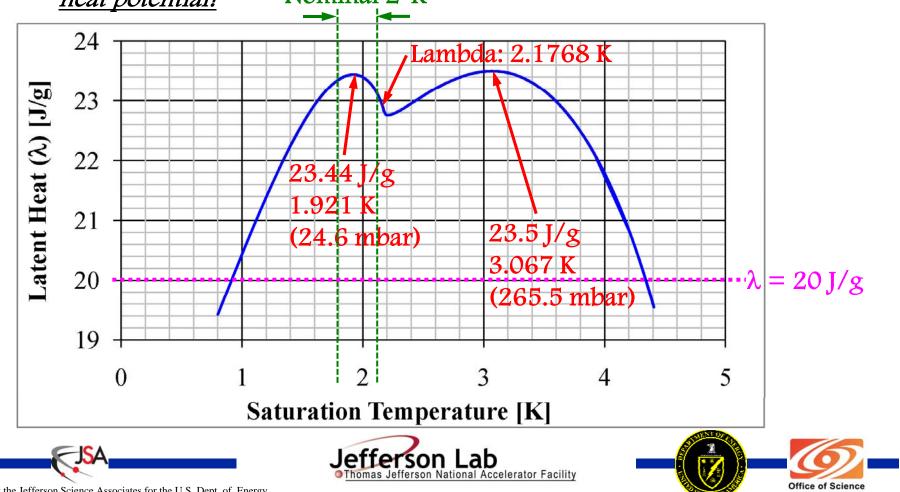


• Helium: Saturation temperature vs. pressure

<u>Note</u>: logarithmic scale for pressure; also, vapor density behavior is similar. This has a dramatic effect on equipment size (to process the sub-atm flow)!



- Helium: Latent heat of vaporization
 - To date we accept $\lambda \approx 20 \text{ J/g}$ as the useful latent heat for most of the superconducting applications; *this leaves behind up to ~17% of un-utilized latent heat potential!* "Nominal 2-K"



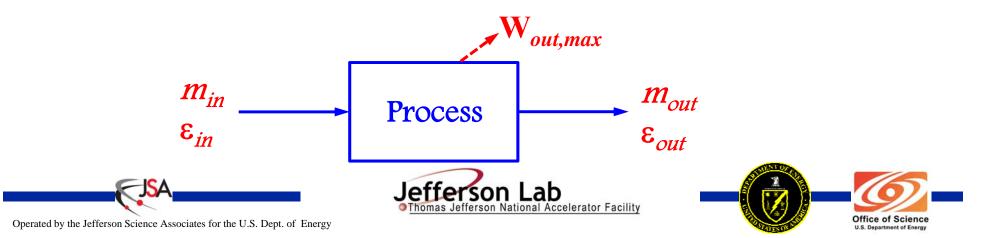
• (Physical) exergy per unit mass is defined as,

 $\varepsilon = h - T_0 \cdot s$

- where, T_0 is the reference temperature; i.e., environmental temperature; say, 300 K
- exergy (ϵ) is an intrinsic fluid property (...like *h* and *s*)
- The minimum input power theoretically required; or conversely, the maximum power output theoretically possible is,

$$\Delta \mathbf{E} = \mathbf{W}_{out,max} = -\mathbf{W}_{in,min} = \Sigma \ \mathbf{m}_{in} \cdot \mathbf{\varepsilon}_{in} - \Sigma \ \mathbf{m}_{out} \cdot \mathbf{\varepsilon}_{out}$$

- also, known as the reversible (input or output) power



• A common measure of process efficiency is the ratio of the ideal (or theoretical) input power to the actual (or real) input power required; known as the *overall exegetic efficiency*,

 $\eta_C = \Delta E / \mathbf{W}_{in}$

- Where, W_{in} is the actual (real) required input power
- One measure of process performance is the ratio of the input power required (either ideal or real) to the cooling provided; known as the *inverse coefficient of performance*,

Ideal (theoretical), $COP_{inv,i} = \Delta E / q_L$

Real, $COP_{inv,r} = W_{in} / q_L$

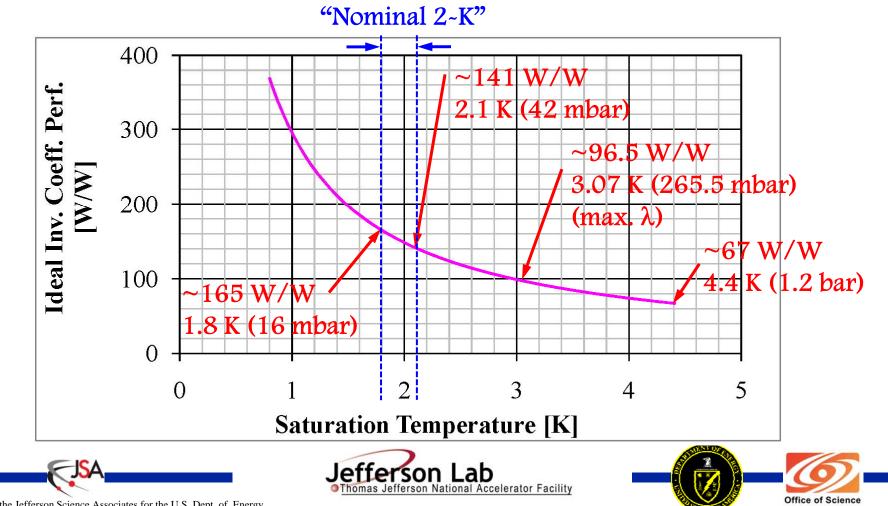
– Where, q_L is the cooling (load) provided







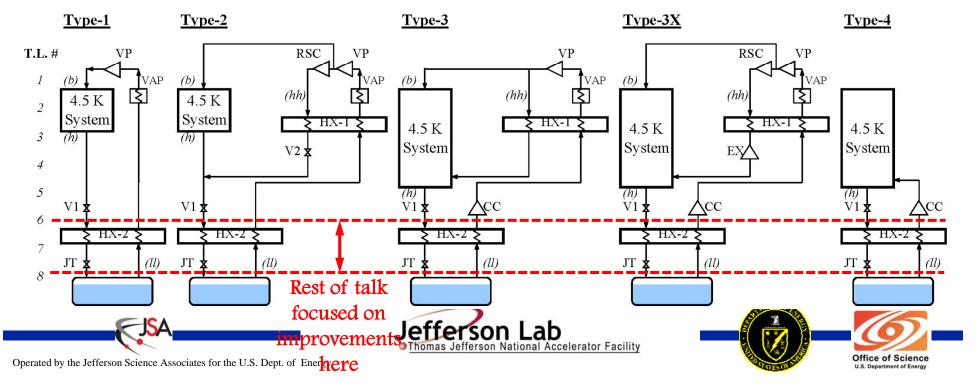
• Ideal (theoretically minimum) $\text{COP}_{inv,i}$ for helium (isothermal) refrigeration,

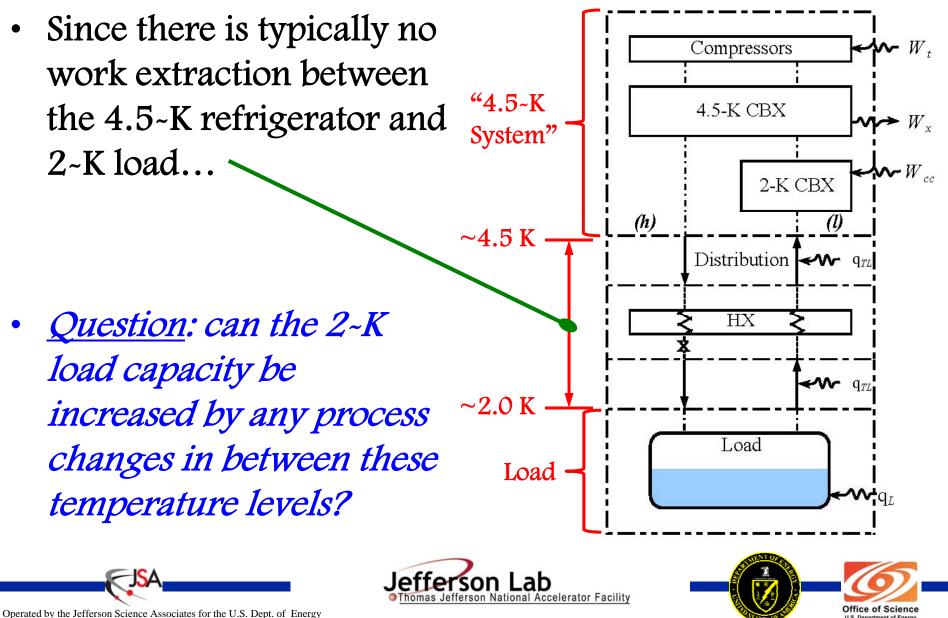


- Lowering the load temperature is expensive, as well as, increases the equipment sizes!
 - Compared to a 4.4 K (1.2 atm) load (which is at positive pressure), the factor increase in <u>ideal</u> input power for the same load, $(COP_{inv,i})_{ratio}$, and vapor density ratio, ρ_{ratio} (as compared to 1.2 atm), is

	T [K]	p [mbar]	(COP _{inv,i}) ratio	ρ _{ratio}
Reference ►	4.4	1200	1.0	1.0
	3.07	266	1.4	4.1
	2.1	42	2.1	20
	1.8	16	2.5	45
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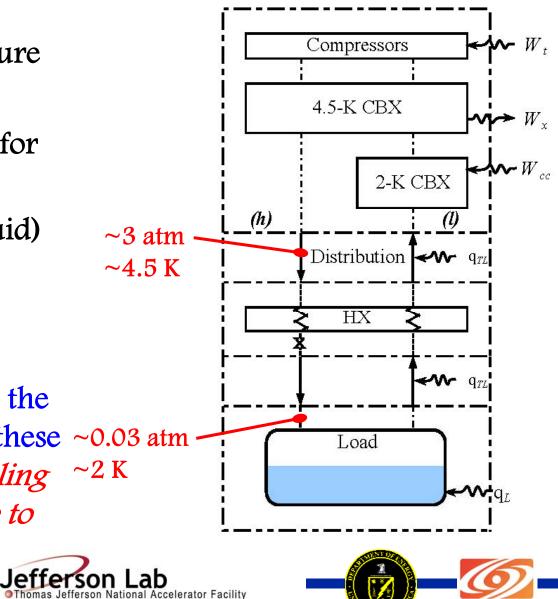
- Four basic configuration types of processes for nominal 2-K helium systems
 - Type-1: Direct vacuum pumping (with or without a 4.5 to 2-K HX); e.g., Triumf E-Linac
 - Type-2: Utilizes an unbalanced refrigeration recovery HX and NO cryogenic rotating machinery; e.g., DESY TTF
 - Type-3: Has several variants, but each uses partial cold compression (1 to 3 stages) and an unbalanced refrigeration recovery HX; one incorporates an expander (-3X); e.g., CERN LHC, Rosendorf-Elbe, MSU-FRIB, etc.
 - Type-4: Uses all cold compression (four stages); e.g., JLab, SNS





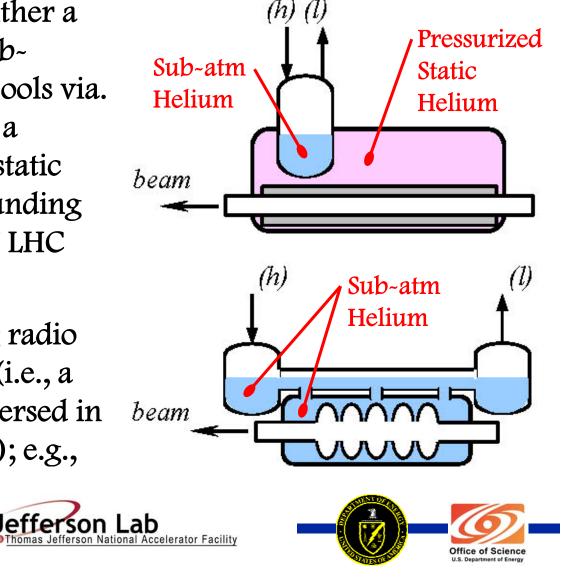
- For thermo-hydraulic reasons, the supply pressure to the load is usually
 - ~3 atm (super-critical) for large systems and,
 - ~1.2 atm (saturated liquid) for small systems
- But the load is subatmospheric (what about the availability lost between these ~0.03 atm pressures...that is, *throttling* ~2 K *from the supply pressure to* 0.03 atm?)...

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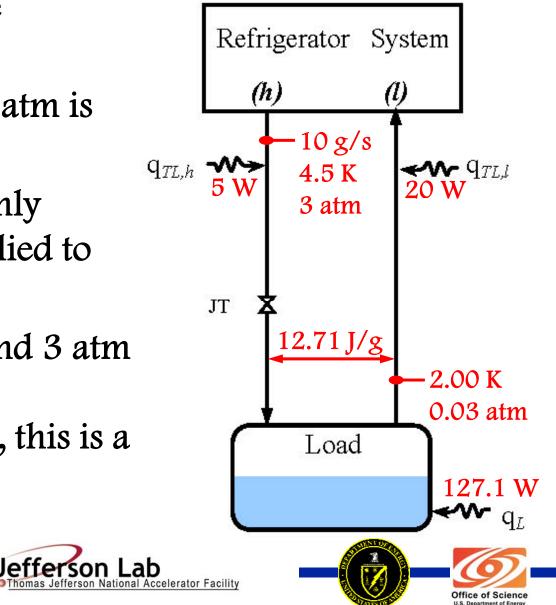


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- A side note...
 - The "Load" is usually either a magnet string (i.e., a sub-atmospheric bath that cools via. super-fluid conduction a 'pressurized' (~1 atm) static helium reservoir surrounding the magnet); e.g., CERN LHC
 - Or, a super-conducting radio frequency (SRF) cavity (i.e., a niobium 'cavity' is immersed in sub-atmospheric liquid); e.g., JLab



- Why is heat exchange necessary?
 - Latent heat at 0.03 atm is
 23.41 J/g
 - Without any HX, only
 ~12.71 J/g is supplied to the load
 - For 10 g/s, 4.5 K and 3 atm supply from the refrigerator system, this is a load of 127.1 W



10 g/s

4.5 K

3 atm

 $q_{TL,h} \sim 5$

JT

Refrigerator

3<u>.34 NTU</u>

ΗX

0.2 K

 $18.69 \, J/g$

Load

(h)

- JLab design (1980's)
 - By adding a HX, the load can be increase (by a factor of ~1.5) for the same refrigerator supply
 - Typical HX cold-end (CE) stream temperature difference is 0.2 K; chosen for practical reasons:
 - Keep (h) stream leaving HX above lambda
 - Realistic HX design





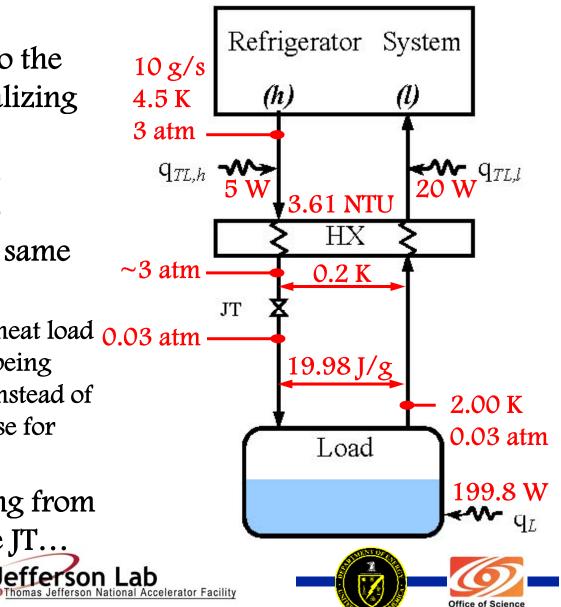


System

2.00 K

0.03 atm

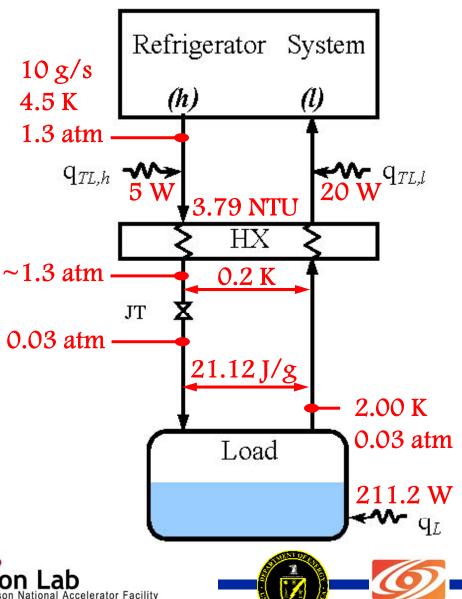
- SNS design (~2002)
 - By distributing the HX to the load (rather than centralizing it near the refrigerator system), the load can be increase above the 'JLab design' by ~7%) for the same refrigerator supply
 - Due to the transfer-line heat load 0.03 atm (20 W in this example) being adsorbed at ~4 K level; instead of the 2 K level ,as is the case for the JLab design
 - But, we are still throttling from 3 to 0.03 atm across the JT...



- For 2-K systems where it is acceptable for the refrigerator system to supply (say) ~ 1.3 atm saturated liquid (4.5~K)
 - Load increase of ~6% compared to SNS design
 - We are analyzing whether to recommend to SNS dropping their supply pressure from 3 to ~1.3 atm
- <u>Note</u>: for thermo-hydraulic stability reasons, a supply pressure of 1.3 atm may not be practical





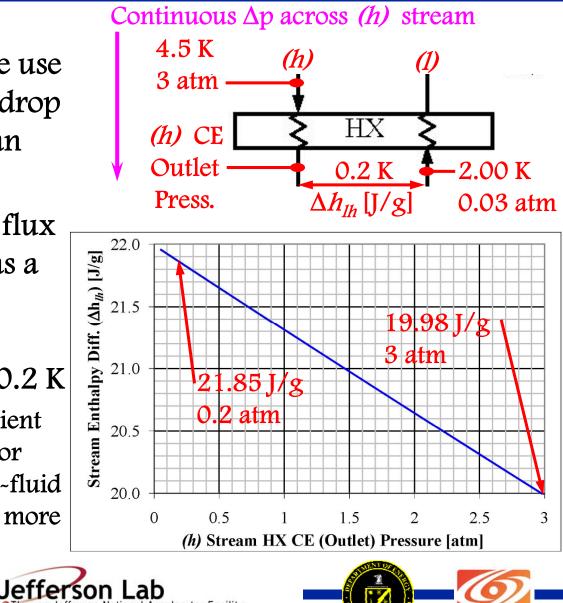


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- This could suggest a (exergetically) constructive use of the (h) stream pressure drop through the HX, rather than across the JT valve
- Figure shows the enthalpy flux at the HX cold (load) end as a function of the CE (outlet) pressure, for a stream CE temperature difference of 0.2 K
- <u>Note</u>: use 0.2 K to provide sufficient stream temperature difference for heat transfer and to avoid super-fluid in HX., this could be somewhat more or less than this value

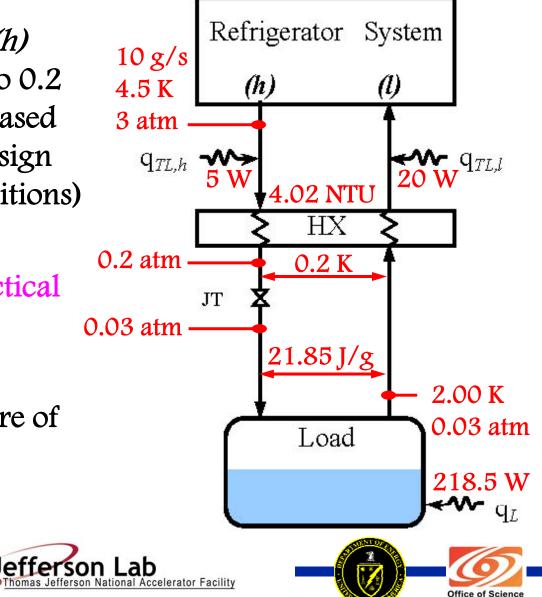






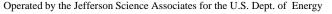
- So, if there is a (built-in) pressure drop across the (h) stream of the HX from 3 to 0.2 atm, the load can be increased by ~9.5% over the SNS design (for the same supply conditions)
- Note that this is <u>not</u> a practical design
- Why was an outlet pressure of 0.2 atm chosen?





- That is,
 - Why stop at 0.2 atm...
 - and not take the pressure drop through the (h) stream of the HX from 3 atm, all the way down to 0.03 atm...
 - getting the entire latent heat for the load (i.e., 23.42 J/g, or in the examples given, 234.1 W)?

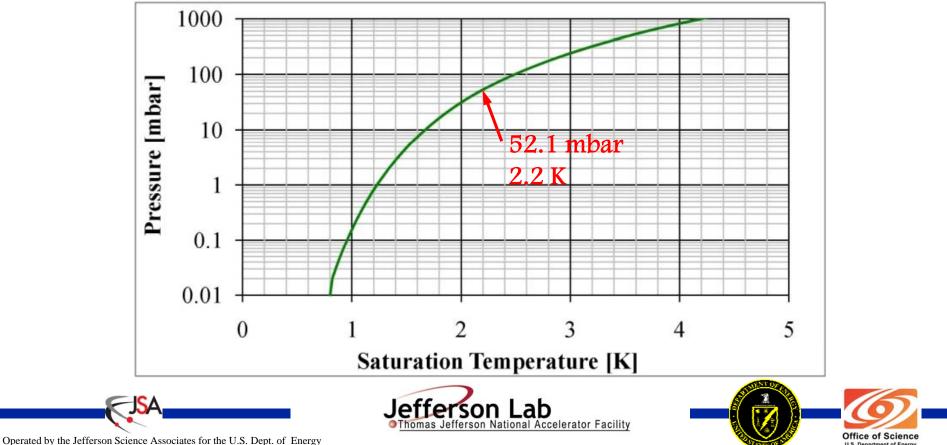








• First, the HX CE stream temperature difference of 0.2 K (which represents a practical value to design the HX around) presents a fluid property limit of 0.0514 atm as the saturation temperature at (2.0 + 0.2 =) 2.2 K

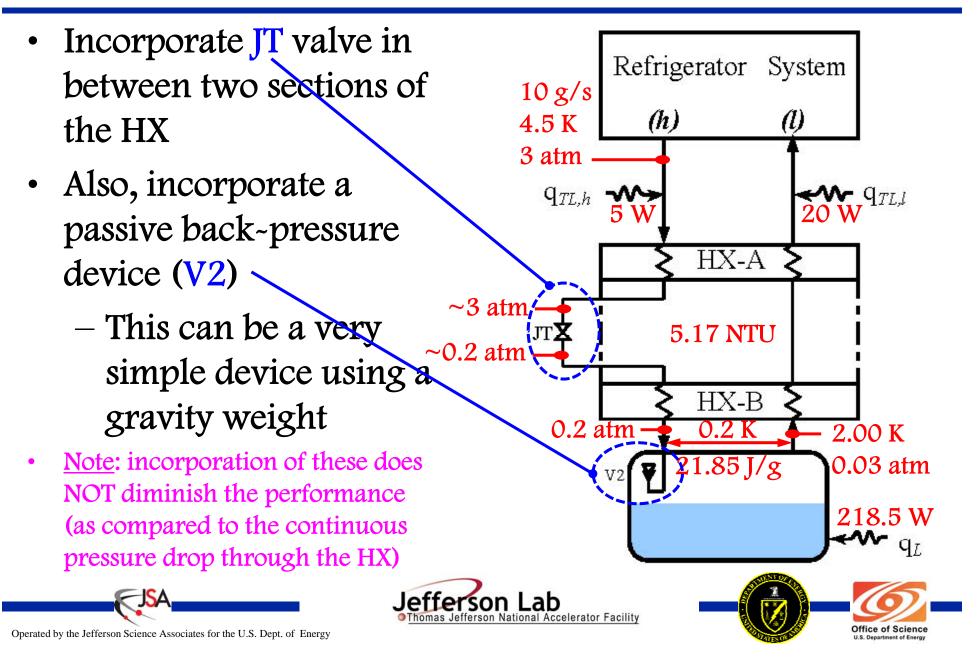


- Second, designing a HX with a specific pressure drop,
 - especially under nominal variations expected in design vs. actual hardware (and loads),
 - and under transient conditions, such as cool-down,
 - is not practical
- So, a variation of the design is needed to practically implement this idea...









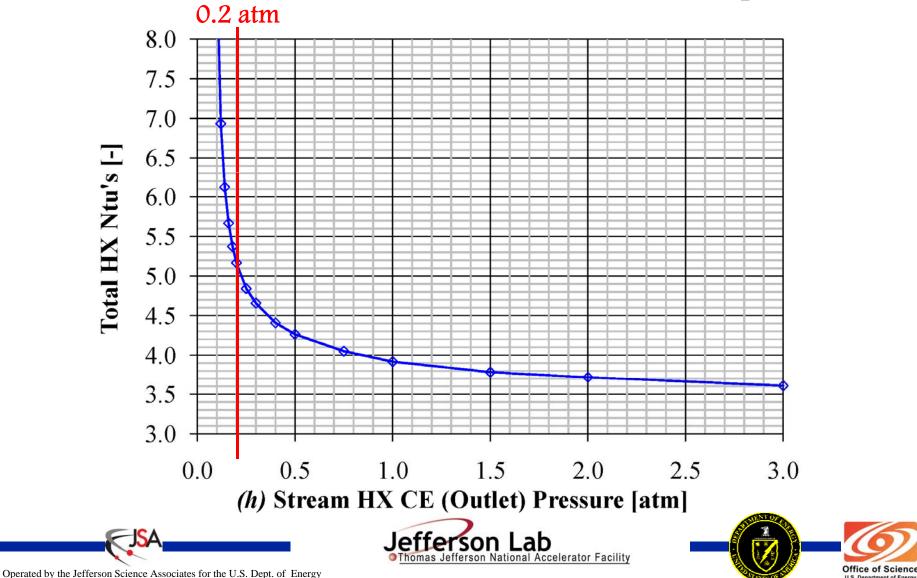
- So, why not 0.0514 atm, instead of 0.2 atm...?
- Because the required HX size (which is quantified using NTU's or UA) would be too large
 NTU or (UA) ▷∞, as the pressure ▷ 0.0514 atm
- Refrigerator System 10 g/s(h) 4.5 K 3 atm ► q_{TL,l} $q_{TL,h}$ HX-A 3 atm 5.17 NTU ~0.2 atm HX-B 0.2 atm 2.00 K 0.03 atm 218.5 W \mathbf{q}_L Jefferson Lab nomas Jefferson National Accelerator Facility

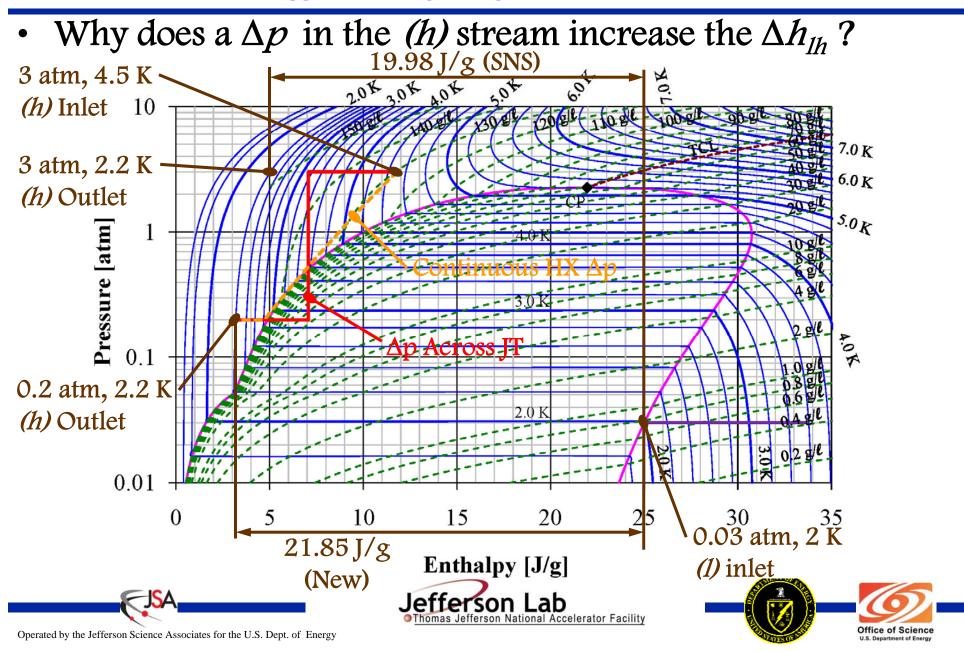
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- <u>Note</u>:
 - (UA) ~ HX flow cross-section or total volume

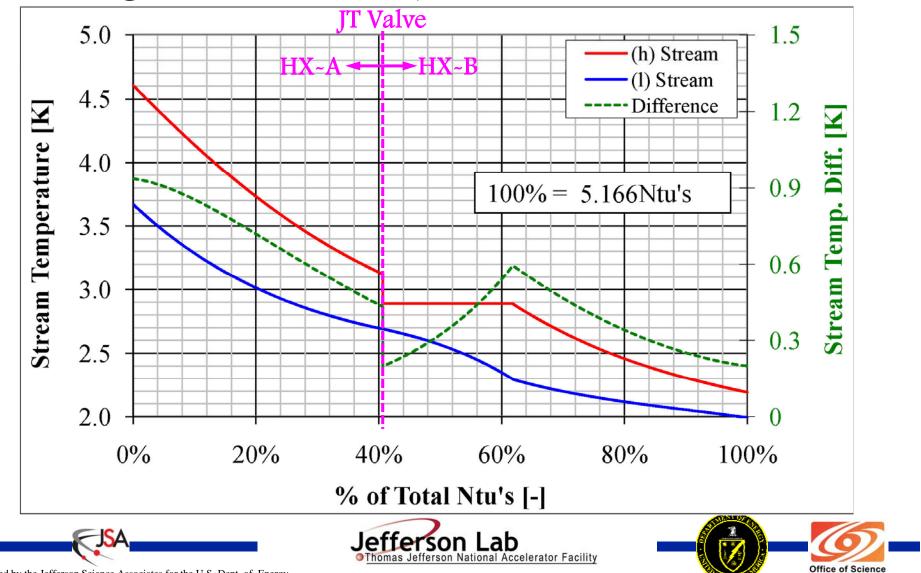
NTU ~ HX length

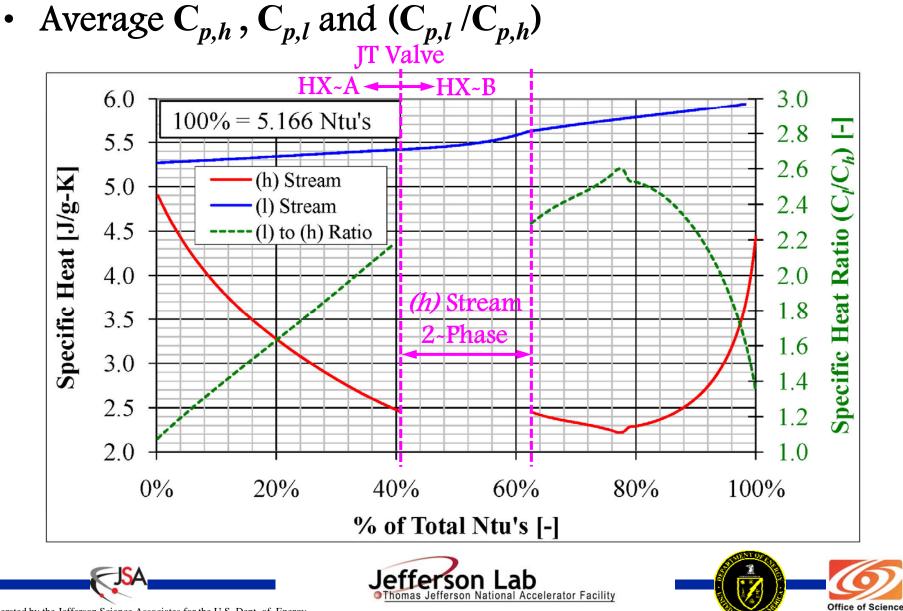
• HX total NTU's vs. (h) stream HX CE (outlet) pressure



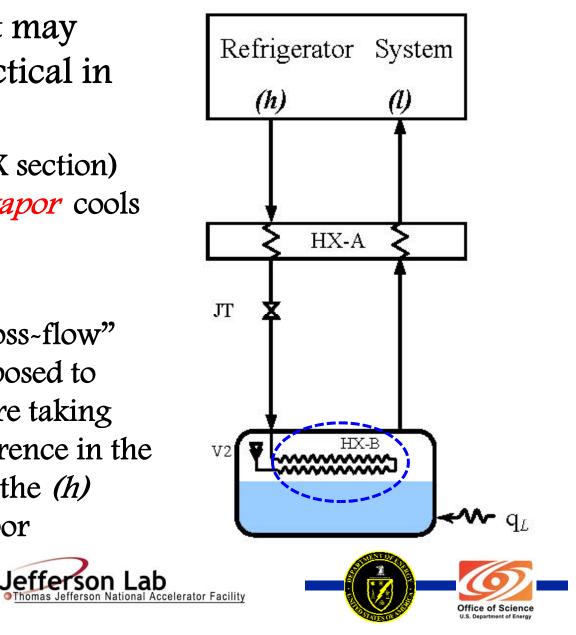


• Cooling curve for HX (i.e., HX-A and HX-B)

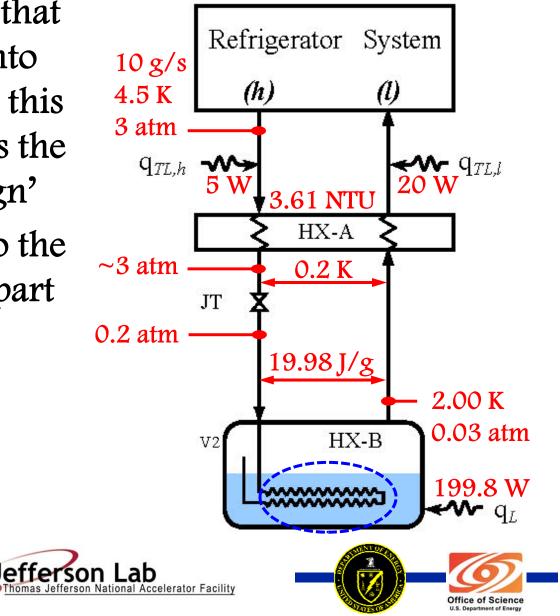




- A slight variation that may prove to be more practical in some configurations
 - Move HX~B (lower HX section) into load, where the *vapor* cools the *(h)* stream
 - Note: Since this is "cross-flow" heat exchange (as opposed to "counter-flow") we are taking advantage of the difference in the specific heat between the *(h)* stream and the *(l)* vapor

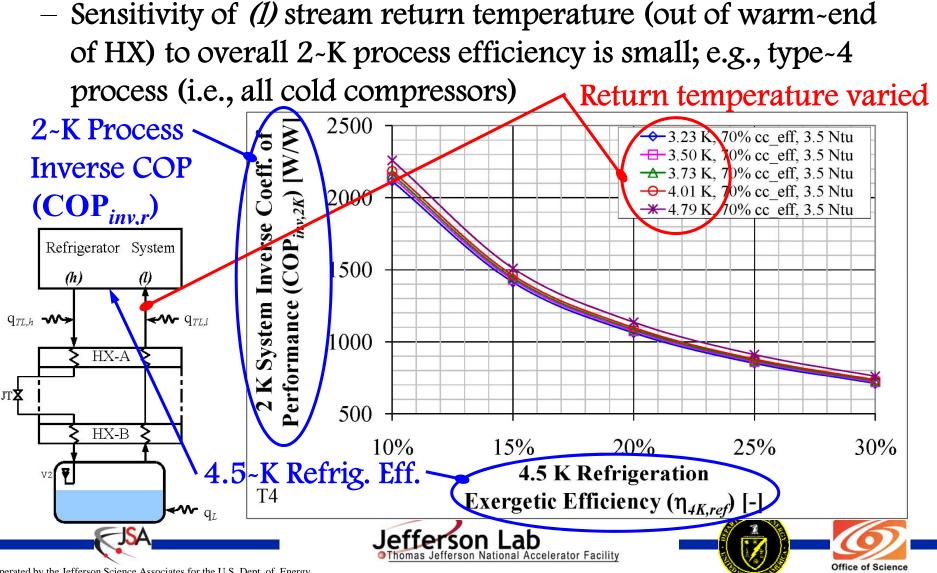


- It is important to note that if HX~B is immersed into (2~K) *liquid bath*, that this configuration becomes the same as the 'SNS Design'
 - HX-B duty goes into the liquid, so it is now part of the load!

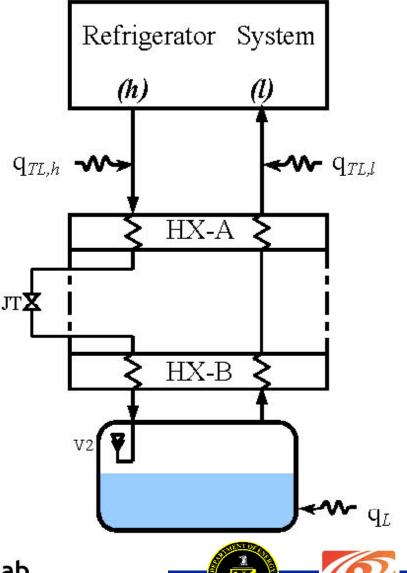




Side note:



- Present development work
 - Designing concept
 validation prototype for
 MSU FRIB (~5 g/s)
 - HX dimensions, approx.7 in diameter by 4 ft long
 - JT valve can be JLab type or commercial
 - Back-pressure valve (V2)
 is similar to a 'gravity'
 check valve









- Retro-fit of existing systems
 - Probably possible in many circumstances
 - But would need to be examined to see if the operational cost savings (from implementing modifications) reimburse the capital cost of re-work and operational cost of down-time in an acceptable period
 - If the existing system is similar to JLab's design, the implementation of this process could result in ~17% increase in load capacity (for the same input power)







- <u>Summary</u>: This cold end process improvement is applicable for *all* nominal 2-K helium systems and could result in,
 - A <u>9.3% load capacity increase</u> for the same input power for the 3 atm supply (as would be common in large systems)
 - or conversely, a <u>9.3% power reduction</u> for the same load (supplied at 3 atm)
 - For a system that is roughly the size of MSU FRIB; i.e. 18 kW of 4.5-K refrigeration (equivalent),
 - Capital cost reduction $\sim 6\%$; e.g., 6% of \$40M = \$2.4M
 - Operational cost reduction; e.g., 9.3% of 4.3 MW = 400 kW
 » At \$0.05 kWh, ~\$175k per year (for 8760 h)
 - <u>Ref</u>. Knudsen, P., Ganni, V., "Cold End Process Options for Nominal Efficiency Improvements," JLab Technical Note 11-014, 2011
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